Docket No.: YPL-0236

FORM PTO-1595 (Modified) RECORDATION FO	RM COVER SHEET U.S. DEPARTMENT OF COMMERCE
OMB No. 0661-0027 (exp.5/31/2002) POEA/REVOI POEA/REVOI PATENTS ONLY Patent and Trademark Office	
Tab settings → → → ▼	▼ ▼ ▼
To the Director of the United States Patent and Trademark Office: Please record the attached original documents or copy thereof.	
1. Name of conveying party(les):	Name and address of receiving party(les):
Kwang-wook OH, Kak NAMKOONG, Chin-sung PARK	Name: Samsung Electronics Co., Ltd.
	Address: 416, Maetan-dong, Yeongtong-gu
Additional names(s) of conveying party(ies)	Addition of the state of the st
3. Nature of conveyance:	
🖾 Assignment 🗆 Merger	
☐ Security Agreement ☐ Change of Name	City: Suwon-si State/Prov.: Gyeonggi-do
☐ Other	Country: Republic of Kores ZIP:
Execution Date: April 13, 2006	Additional name(s) & address(es) 🗀 Yes 🖾 No
4. Application sumbar(a) or patent numbers(a):	
4. Application number(s) or patent numbers(s):	
If this document is being filed together with a new application, t	The execution date of the application is.
Patent Application No. Filing date	B. Patent No.(s)
11/396,764 04/03/2006 Additional numbers	☐ Yas ⊠ No
Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Name: Amy Bizon-Copp	7. Total fee (37 CFR 3.41):\$ 40.00
Registration No. 53,993	☐ Enclosed - Any excess or insufficiency should be
Address: Cantor Colburn LLP	credited or debited to deposit account
55 Griffin Road South	Authorized to be charged to deposit account
	8. Deposit account number:
City: Bloomfield State/Prov.: CT	06-1130
Country: USA ZIP: 06002	(Attach duplicate copy of this page if paying by deposit account)
DO NOT USE THIS SPACE	
9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Any Bizon-Copp May 24, 2006	
Amy Bizon-Copp YUTUA Name of Person Signing	Signature
Total number of pages including cover sheet, attachments, and document:	

ASSIGNMENT

WHEREAS We, [Kwang-wook Oh] of [102-1802 Sinyeongtong Hyundai Apt., 860 Banwol-ri, Taean-cub, Hwaseong-ai, Gyeonggi-do, Republic of Korea], [Kuk Namkoong] of [402, 291-17 Seokchon-dong, Songpa-gu, Seoul, Republic of Korea], and [Chin-sung Park] of [311-1601 Hyundai Morningside 1-cha Apt., 570 Bora-ri, Giheung-cub, Yongin-si, Gyeonggi-do, Republic of Korea] (hereinafter referred to as "ASSIGNORS"); have invented certain new and useful improvements in:

(MICROVALVE HAVING MAGNETIC WAX PLUG AND FLUX CONTROL METHOD USING MAGNETIC WAX)

which claims priority to [Korean] Application No. <u>10-2005-0027829</u> filed on <u>2 April 2005</u>, and for which We are about to file an application for Letters Patent of the United States;

AND WHEREAS, [Samsung Electronics Co., Ltd.] (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the Country of [Republic of Korea], having a place of business at [416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea], is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor:

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and valuable consideration, the receipt of which is hereby acknowledged, We, the said ASSIGNORS have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, rafitings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEE, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEE, its successors and assigns; and We do hereby agree that the said ASSIGNEE, may apply for foreign Letters Patent on said invention and that We will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that We will,

PATENT REEL: 017679 FRAME: 0739

at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declars that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

L.S.

PATENT

REEL: 017679 FRAME: 0740